

ON Semiconductor®

FDBL9403-F085

N-Channel PowerTrench[®] MOSFET 40 V, 240 A, 0.9 m Ω

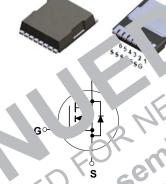
Features

- Typical $R_{DS(on)}$ = 0.65 m Ω at V_{GS} = 10V, I_D = 80 A
- Typical $Q_{g(tot)}$ = 144 nC at V_{GS} = 10V, I_D = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems





MOSFET Maximum Rating . 25 unless sherwise noted.

Symbol	rameter	Ratings	Units
V_{DSS}	Drain-to-Sr , ce Voltage	40	V
V_{GS}	Gate-to-Sc 'ce Volta' ?	±20	V
ı	F ain currei Con⁴ Jous (V _G , -12) (Note 1) T _C -25 °C	240	Α
ID	n Current $\mathcal{T}_{\mathbb{C}}$ = 25°C	See Figure 4	
FAS	Single Pr : Avalanche E nergy (Note 2)	737	mJ
PD	'owe, Jissipation	357	W
r _D	L Jiate Abo 'e 2 ⁵ °C	2.38	W/°C
T_J, T_G	Operating and Storage Temperature	-55 to + 175	°C
, ic	Thermal Resistance, Junction to Case	0.42	°C/W
$R_{\theta J \Lambda}$	Maximum 1 hermal Resistance, Junction to Ambient (Note 3)	43	°C/W

Notes:

- 1: Current is limited by bond vire configuration.
- 2: Starting $T_J = 25^{\circ}C$, L = 0.36mH, $I_{AS} = 64$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3: R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,JC} is guaranteed by design, while R_{0,JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

Device Marking	Device	Package			
FDBL9403	FDBL9403-F085	MO-299A	-	-	-

Units

Max.

Electrical Characteristics $T_J = 25$ °C unless otherwise noted.

Parameter

Off Characteristics							
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA,	V _{GS} = 0V	40	-	-	V
I _{DSS}	Drain-to-Source Leakage Current $V_{DS}=40V$, $V_{GS}=40V$, $V_{J}=25^{\circ}C$ $V_{J}=175^{\circ}C$ (Note 4)	V _{DS} =40V,	$T_J = 25^{\circ}C$	-	-	1	μΑ
		-	-	1	mA		
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

Test Conditions

Min.

Тур.

On Characteristics

Symbol

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, I	_D = 250μA	2.0	3 2		V
D	Drain to Source On Resistance	I _D = 80A,	$T_{J} = 25^{\circ}C$	1	0.	0.9	$m\Omega$
R _{DS(on)}	Dialii to Source On Resistance	V _{GS} = 10V	$T_J = 175^{\circ}C \text{ (Note 4)}$		1.16	1.5	mΩ

Dynamic Characteristics

C _{iss}	Input Capacitance	V 05V V 0V	.2000 -	pF
C _{oss}	Output Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz	326 / -	pF
C _{rss}	Reverse Transfer Capacitance	- 1101112	42 -	pF
R_g	Gate Resistance	f = 1MH-	3.3	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	V _C 1 to 10 = 32V	14 188	110
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 2V$ $I_D = 80A$ -	23	nC
Q_{gs}	Gate-to-Source Gate Charge	0000	66	nC
Q_{gd}	Gate-to-Drain "Miller" Charge	NV IR	16 -	nC

Switching Characteristic

	Time On Tim	$\rightarrow \rightarrow$		400	
ton	Turn-On Tir	-	-	162	ns
$t_{d(on)}$	Turn-On [lay	-	42	-	ns
t _r	P' 'me $V_{DD} = 20 \text{ V}, I_D = 80 \text{ A},$	-	73	-	ns
$t_{d(off)}$	$\text{urn-Off Del}_{\text{C}} = 10V, R_{\text{GEN}} = 6\Omega$	-	83	-	ns
t _f	I TIME	-	50	-	ns
	Tu of time	-	-	279	ns

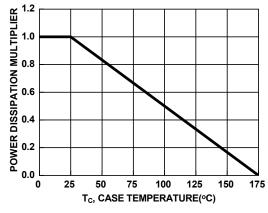
Drail Solice Characteristics

	Source-to-Prain Diode Voltage	I_{SD} =80A, V_{GS} = 0V	-	-	1.25	V
70	Scurse-to-1 . a. (i Disue voltage	I_{SD} = 40A, V_{GS} = 0V	-	-	1.2	V
t _{rp}	Reverse-Recovery Time	$I_F = 80A$, $dI_{SD}/dt = 100A/\mu s$,	-	111	129	ns
$\mathcal{O}^{\mathrm{tt}}$	Reverse-Recovery Charge	V _{DD} =32V	-	178	214	nC

Note:

4: The maximum value 13 specified by design at T_J = 175°C. Product is not tested to this condition in production.

Typical Characteristics



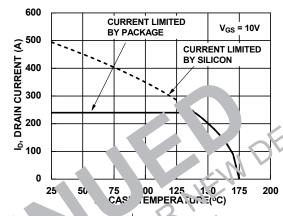
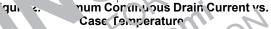
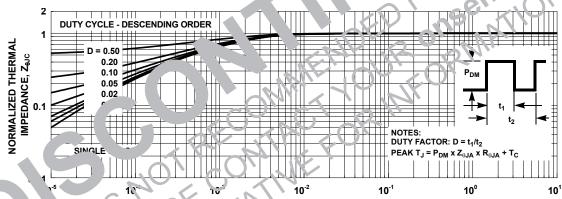


Figure 1. Normalized Power Dissipation vs. Case Temperature





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Figure 3. Normalized Maximum Transient Thermal Impedance

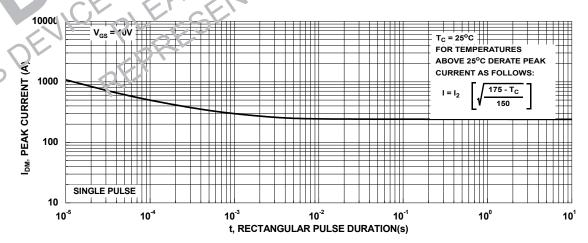


Figure 4. Peak Current Capability

Typical Characteristics

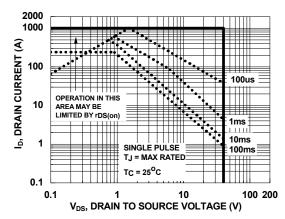
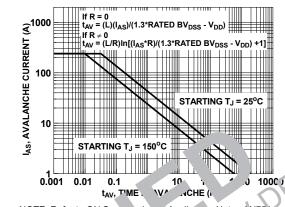
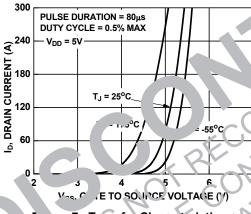


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Sem. nduc Applir on Note: AN75 4 and AN7515

Figure Un ampe Inductive Switching Car sility



F. re 7. Transfer Characteristics

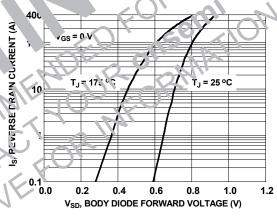


Figure 8. Forward Diode Characteristics

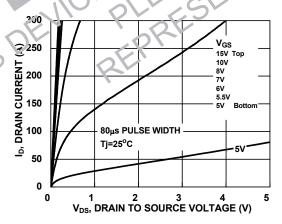


Figure 9. Saturation Characteristics

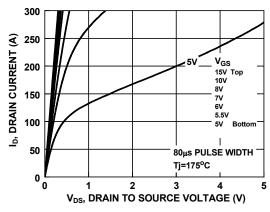


Figure 10. Saturation Characteristics

Typical Characteristics

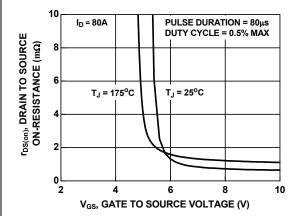


Figure 11. R_{DSON} vs. Gate Voltage

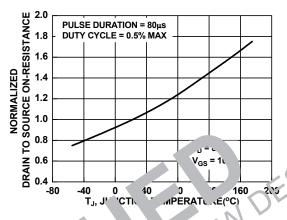
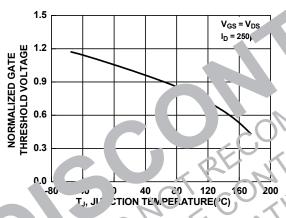


Figure 12 Norma rea SON vs. Junction Ten prature



Figu 15 lormalized Gate Threshold Voltage vs.

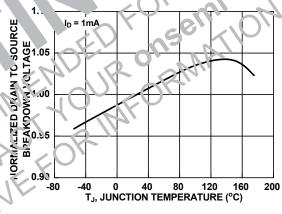


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

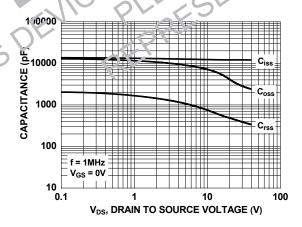


Figure 15. Capacitance vs. Drain to Source Voltage

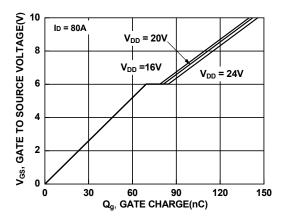


Figure 16. Gate Charge vs. Gate to Source Voltage



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